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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	M16C/60
Core Size	16-Bit
Speed	24MHz
Connectivity	I <sup>2</sup> C, IEBus, UART/USART
Peripherals	DMA, WDT
Number of I/O	68
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-BQFP
Supplier Device Package	80-QFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/m30621fcpgp-u9c">https://www.e-xfl.com/product-detail/renesas-electronics-america/m30621fcpgp-u9c</a>

## 1.2 Performance Outline

Table 1.1 to 1.3 list Performance Outline of M16C/62P Group (M16C/62P, M16C/62PT)(128-pin version).

**Table 1.1 Performance Outline of M16C/62P Group (M16C/62P, M16C/62PT)(128-pin version)**

	Item	Performance
		M16C/62P
CPU	Number of Basic Instructions	91 instructions
	Minimum Instruction Execution Time	41.7ns(f(BCLK)=24MHz, VCC1=3.3 to 5.5V) 100ns(f(BCLK)=10MHz, VCC1=2.7 to 5.5V)
	Operating Mode	Single-chip, memory expansion and microprocessor mode
	Address Space	1 Mbyte (Available to 4 Mbytes by memory space expansion function)
	Memory Capacity	See Table 1.4 to 1.5 Product List
Peripheral Function	Port	Input/Output : 113 pins, Input : 1 pin
	Multifunction Timer	Timer A : 16 bits x 5 channels, Timer B : 16 bits x 6 channels, Three phase motor control circuit
	Serial Interface	3 channels Clock synchronous, UART, I <sup>2</sup> C bus <sup>(1)</sup> , IEBus <sup>(2)</sup> 2 channels Clock synchronous
	A/D Converter	10-bit A/D converter: 1 circuit, 26 channels
	D/A Converter	8 bits x 2 channels
	DMAC	2 channels
	CRC Calculation Circuit	CCITT-CRC
	Watchdog Timer	15 bits x 1 channel (with prescaler)
	Interrupt	Internal: 29 sources, External: 8 sources, Software: 4 sources, Priority level: 7 levels
	Clock Generation Circuit	4 circuits Main clock generation circuit (*), Subclock generation circuit (*), On-chip oscillator, PLL synthesizer (*)Equipped with a built-in feedback resistor.
	Oscillation Stop Detection Function	Stop detection of main clock oscillation, re-oscillation detection function
	Voltage Detection Circuit	Available (option <sup>(4)</sup> )
Electric Characteristics	Supply Voltage	VCC1=3.0 to 5.5 V, VCC2=2.7V to VCC1 (f(BCLK)=24MHz) VCC1=2.7 to 5.5 V, VCC2=2.7V to VCC1 (f(BCLK)=10MHz)
	Power Consumption	14 mA (VCC1=VCC2=5V, f(BCLK)=24MHz) 8 mA (VCC1=VCC2=3V, f(BCLK)=10MHz) 1.8μA (VCC1=VCC2=3V, f(XCIN)=32kHz, wait mode) 0.7μA (VCC1=VCC2=3V, stop mode)
Flash memory version	Program/Erase Supply Voltage	3.3±0.3 V or 5.0±0.5 V
	Program and Erase Endurance	100 times (all area) or 1,000 times (user ROM area without block A and block 1) / 10,000 times (block A, block 1) <sup>(3)</sup>
Operating Ambient Temperature		-20 to 85°C, -40 to 85°C <sup>(3)</sup>
Package		128-pin plastic mold LQFP

### NOTES:

1. I<sup>2</sup>C bus is a registered trademark of Koninklijke Philips Electronics N. V.
2. IEBus is a registered trademark of NEC Electronics Corporation.
3. See **Table 1.8 Product Code** for the program and erase endurance, and operating ambient temperature. In addition 1,000 times/10,000 times are under development as of Jul., 2005. Please inquire about a release schedule.
4. All options are on request basis.

**Table 1.3 Performance Outline of M16C/62P Group (M16C/62P, M16C/62PT)(80-pin version)**

	Item	Performance	
		M16C/62P	M16C/62PT <sup>(4)</sup>
CPU	Number of Basic Instructions	91 instructions	
	Minimum Instruction Execution Time	41.7ns(f(BCLK)=24MHz, VCC1=3.3 to 5.5V) 100ns(f(BCLK)=10MHz, VCC1=2.7 to 5.5V)	41.7ns(f(BCLK)=24MHz, VCC1=4.0 to 5.5V)
	Operating Mode	Single-chip mode	
	Address Space	1 Mbyte	
	Memory Capacity	See <b>Table 1.4 to 1.7 Product List</b>	
Peripheral Function	Port	Input/Output : 70 pins, Input : 1 pin	
	Multifunction Timer	Timer A : 16 bits x 5 channels (Timer A1 and A2 are internal timer), Timer B : 16 bits x 6 channels (Timer B1 is internal timer)	
	Serial Interface	2 channels Clock synchronous, UART, I <sup>2</sup> C bus <sup>(1)</sup> , IEBus <sup>(2)</sup> 1 channel Clock synchronous, I <sup>2</sup> C bus <sup>(1)</sup> , IEBus <sup>(2)</sup> 2 channels Clock synchronous (1 channel is only transmission)	
	A/D Converter	10-bit A/D converter: 1 circuit, 26 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	2 channels	
	CRC Calculation Circuit	CCITT-CRC	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	Internal: 29 sources, External: 5 sources, Software: 4 sources, Priority level: 7 levels	
	Clock Generation Circuit	4 circuits Main clock generation circuit (*), Subclock generation circuit (*), On-chip oscillator, PLL synthesizer (*)Equipped with a built-in feedback resistor.	
	Oscillation Stop Detection Function	Stop detection of main clock oscillation, re-oscillation detection function	
	Voltage Detection Circuit	Available (option <sup>(4)</sup> )	Absent
Electric Characteristics	Supply Voltage	VCC1=3.0 to 5.5 V, (f(BCLK)=24MHz) VCC1=2.7 to 5.5 V, (f(BCLK)=10MHz)	VCC1=4.0 to 5.5V, (f(BCLK)=24MHz)
	Power Consumption	14 mA (VCC1=5V, f(BCLK)=24MHz) 8 mA (VCC1=3V, f(BCLK)=10MHz) 1.8μA (VCC1=3V, f(XCIN)=32kHz, wait mode) 0.7μA (VCC1=3V, stop mode)	14 mA (VCC1=5V, f(BCLK)=24MHz) 2.0μA (VCC1=5V, f(XCIN)=32kHz, wait mode) 0.8μA (VCC1=5V, stop mode)
Flash memory version	Program/Erase Supply Voltage	3.3 ± 0.3V or 5.0 ± 0.5V	5.0 ± 0.5V
	Program and Erase Endurance	100 times (all area) or 1,000 times (user ROM area without block A and block 1) / 10,000 times (block A, block 1) <sup>(3)</sup>	
Operating Ambient Temperature		-20 to 85°C, -40 to 85°C <sup>(3)</sup>	T version : -40 to 85°C V version : -40 to 125°C
Package		80-pin plastic mold QFP	

## NOTES:

- I<sup>2</sup>C bus is a registered trademark of Koninklijke Philips Electronics N. V.
- IEBus is a registered trademark of NEC Electronics Corporation.
- See **Table 1.8 and 1.9 Product Code** for the program and erase endurance, and operating ambient temperature.  
In addition 1,000 times/10,000 times are under development as of Jul., 2005. Please inquire about a release schedule.
- All options are on request basis.

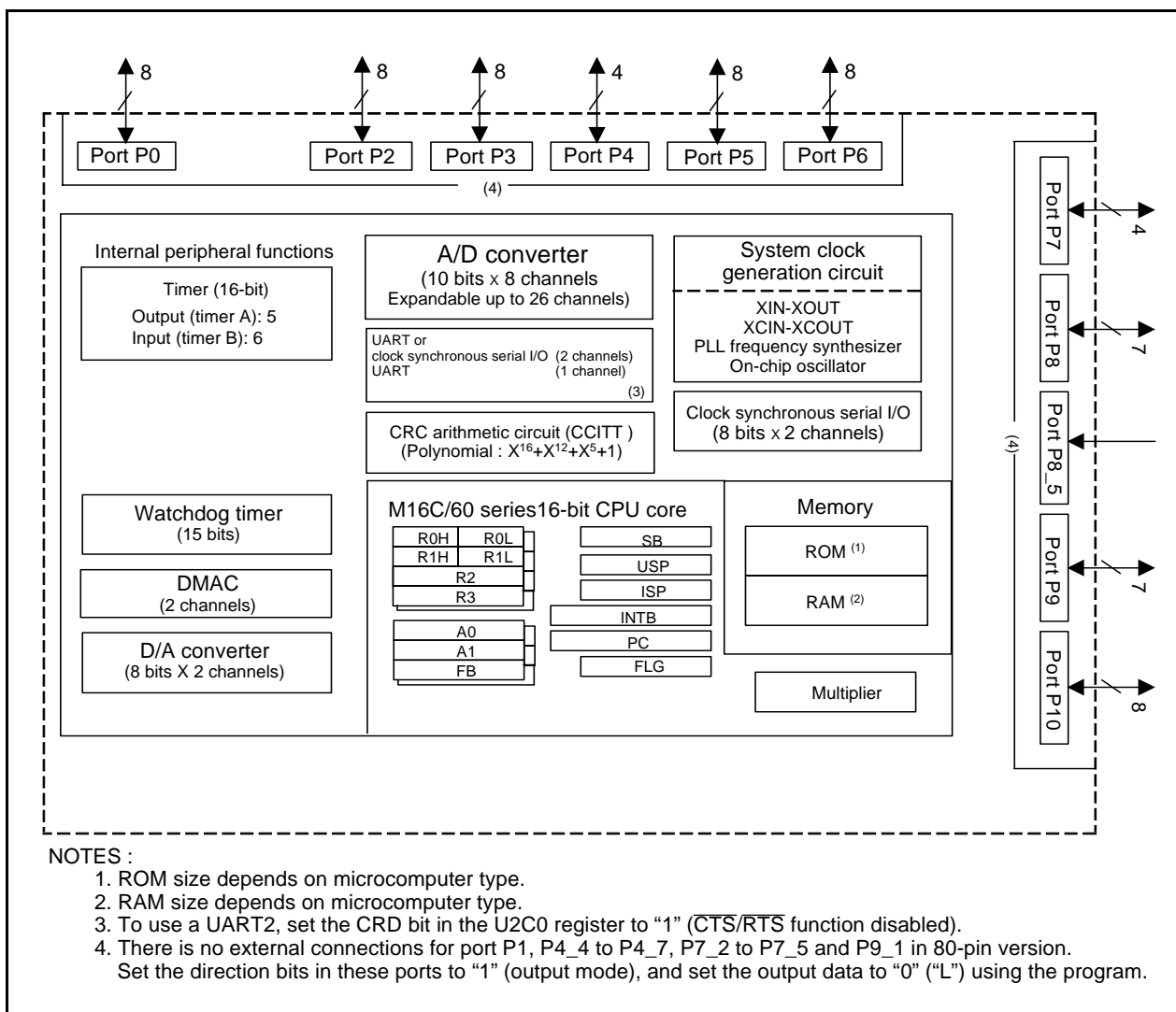


Figure 1.2 M16C/62P Group (M16C/62P, M16C/62PT) 80-pin version Block Diagram

**Table 1.7 Product List (4) (V version (M16C/62PT))****As of Dec. 2005**

Type No.	ROM Capacity	RAM Capacity	Package Type <sup>(1)</sup>	Remarks	
M3062CM6V-XXXFP (P)	48 Kbytes	4 Kbytes	PRQP0100JB-A	Mask ROM version	V Version (High reliability 125°C version)
M3062CM6V-XXXGP (P)			PLQP0100KB-A		
M3062EM6V-XXXGP (P)			PRQP0080JA-A		
M3062CM8V-XXXFP (P)	64 Kbytes	4 Kbytes	PRQP0100JB-A		
M3062CM8V-XXXGP (P)			PLQP0100KB-A		
M3062EM8V-XXXGP (P)			PRQP0080JA-A		
M3062CMAV-XXXFP (P)	96 Kbytes	5 Kbytes	PRQP0100JB-A		
M3062CMAV-XXXGP (P)			PLQP0100KB-A		
M3062EMAV-XXXGP (P)			PRQP0080JA-A		
M3062AMCV-XXXFP (D)	128 Kbytes	10 Kbytes	PRQP0100JB-A		
M3062AMCV-XXXGP (D)			PLQP0100KB-A		
M3062BMCV-XXXGP (P)			PRQP0080JA-A		
M3062AFCVFP (D)	128K+4 Kbytes	10 Kbytes	PRQP0100JB-A	Flash memory version <sup>(2)</sup>	
M3062AFCVGP (D)			PLQP0100KB-A		
M3062BFCVGP (P)			PRQP0080JA-A		
M3062JFHVFP (P)	384K+4 Kbytes	31 Kbytes	PRQP0100JB-A		
M3062JFHVGP (P)			PLQP0100KB-A		

(D): Under development

(P): Under planning

## NOTES:

1. The old package type numbers of each package type are as follows.

PLQP0128KB-A : 128P6Q-A,

PRQP0100JB-A : 100P6S-A,

PLQP0100KB-A : 100P6Q-A,

PRQP0080JA-A : 80P6S-A

2. In the flash memory version, there is 4K bytes area (block A).

**Table 1.13 Pin Characteristics for 100-Pin Package (1)**

Pin No.		Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin	Bus Control Pin
FP	GP							
1	99		P9_6			SOUT4	ANEX1	
2	100		P9_5			CLK4	ANEX0	
3	1		P9_4		TB4IN		DA1	
4	2		P9_3		TB3IN		DA0	
5	3		P9_2		TB2IN	SOUT3		
6	4		P9_1		TB1IN	SIN3		
7	5		P9_0		TB0IN	CLK3		
8	6	BYTE						
9	7	CNVSS						
10	8	XCIN	P8_7					
11	9	XCOUT	P8_6					
12	10	RESET						
13	11	XOUT						
14	12	VSS						
15	13	XIN						
16	14	VCC1						
17	15		P8_5	NMI				
18	16		P8_4	INT2	ZP			
19	17		P8_3	INT1				
20	18		P8_2	INT0				
21	19		P8_1		TA4IN/U			
22	20		P8_0		TA4OUT/U			
23	21		P7_7		TA3IN			
24	22		P7_6		TA3OUT			
25	23		P7_5		TA2IN/W			
26	24		P7_4		TA2OUT/W			
27	25		P7_3		TA1IN/V	CTS2/RTS2		
28	26		P7_2		TA1OUT/V	CLK2		
29	27		P7_1		TA0IN/TB5IN	RXD2/SCL2		
30	28		P7_0		TA0OUT	TXD2/SDA2		
31	29		P6_7			TXD1/SDA1		
32	30		P6_6			RXD1/SCL1		
33	31		P6_5			CLK1		
34	32		P6_4			CTS1/RTS1/CTS0/CLKS1		
35	33		P6_3			TXD0/SDA0		
36	34		P6_2			RXD0/SCL0		
37	35		P6_1			CLK0		
38	36		P6_0			CTS0/RTS0		
39	37		P5_7					RDY/CLKOUT
40	38		P5_6					ALE
41	39		P5_5					HOLD
42	40		P5_4					HLAD
43	41		P5_3					BCLK
44	42		P5_2					RD
45	43		P5_1					WRH/BHE
46	44		P5_0					WRL/WR
47	45		P4_7					CS3
48	46		P4_6					CS2
49	47		P4_5					CS1
50	48		P4_4					CS0

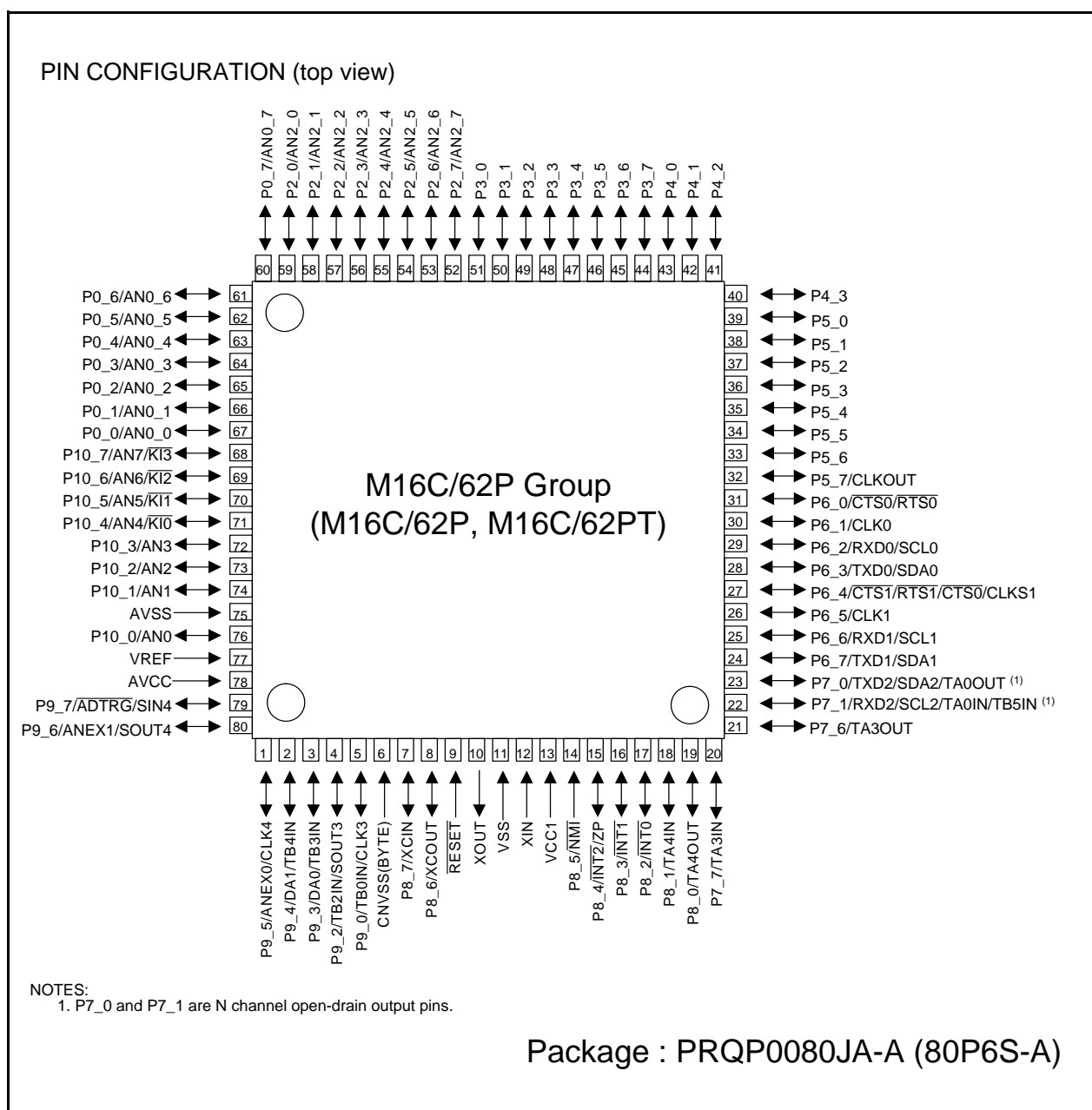


Figure 1.9 Pin Configuration (Top View)

**Table 1.18 Pin Description (100-pin and 128-pin Version) (2)**

Signal Name	Pin Name	I/O Type	Power Supply <sup>(1)</sup>	Description
Main clock input	XIN	I	VCC1	I/O pins for the main clock generation circuit. Connect a ceramic resonator or crystal oscillator between XIN and XOUT <sup>(3)</sup> . To use the external clock, input the clock from XIN and leave XOUT open.
Main clock output	XOUT	O	VCC1	
Sub clock input	XCIN	I	VCC1	I/O pins for a sub clock oscillation circuit. Connect a crystal oscillator between XCIN and XCOUT <sup>(3)</sup> . To use the external clock, input the clock from XCIN and leave XCOUT open.
Sub clock output	XCOUT	O	VCC1	
BCLK output <sup>(2)</sup>	BCLK	O	VCC2	Outputs the BCLK signal.
Clock output	CLKOUT	O	VCC2	The clock of the same cycle as fC, f8, or f32 is outputted.
INT interrupt input	INT0 to INT2	I	VCC1	Input pins for the INT interrupt.
	INT3 to INT5	I	VCC2	
NMI interrupt input	NMI	I	VCC1	Input pin for the NMI interrupt. Pin states can be read by the P8_5 bit in the P8 register.
Key input interrupt input	KI0 to KI3	I	VCC1	Input pins for the key input interrupt.
Timer A	TA0OUT to TA4OUT	I/O	VCC1	These are timer A0 to timer A4 I/O pins. (however, output of TA0OUT for the N-channel open drain output.)
	TA0IN to TA4IN	I	VCC1	These are timer A0 to timer A4 input pins.
	ZP	I	VCC1	Input pin for the Z-phase.
Timer B	TB0IN to TB5IN	I	VCC1	These are timer B0 to timer B5 input pins.
Three-phase motor control output	U, $\bar{U}$ , V, $\bar{V}$ , W, $\bar{W}$	O	VCC1	These are Three-phase motor control output pins.
Serial interface	$\overline{\text{CTS0}}$ to $\overline{\text{CTS2}}$	I	VCC1	These are send control input pins.
	$\overline{\text{RTS0}}$ to $\overline{\text{RTS2}}$	O	VCC1	These are receive control output pins.
	CLK0 to CLK4	I/O	VCC1	These are transfer clock I/O pins.
	RXD0 to RXD2	I	VCC1	These are serial data input pins.
	SIN3, SIN4	I	VCC1	These are serial data input pins.
	TXD0 to TXD2	O	VCC1	These are serial data output pins. (however, output of TXD2 for the N-channel open drain output.)
	SOUT3, SOUT4	O	VCC1	These are serial data output pins.
	CLKS1	O	VCC1	This is output pin for transfer clock output from multiple pins function.
I <sup>2</sup> C mode	SDA0 to SDA2	I/O	VCC1	These are serial data I/O pins. (however, output of SDA2 for the N-channel open drain output.)
	SCL0 to SCL2	I/O	VCC1	These are transfer clock I/O pins. (however, output of SCL2 for the N-channel open drain output.)

I : Input O : Output I/O : Input and output

## NOTES:

1. When use VCC1 > VCC2, contacts due to some points or restrictions to be checked.
2. This pin function in M16C/62PT cannot be used.
3. Ask the oscillator maker the oscillation characteristic.



### **2.8.8 Stack Pointer Select Flag (U Flag)**

ISP is selected when the U flag is “0”; USP is selected when the U flag is “1”.

The U flag is cleared to “0” when a hardware interrupt request is accepted or an INT instruction for software interrupt Nos. 0 to 31 is executed.

### **2.8.9 Processor Interrupt Priority Level (IPL)**

IPL is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than IPL, the interrupt is enabled.

### **2.8.10 Reserved Area**

When write to this bit, write “0”. When read, its content is indeterminate.

**Table 4.2 SFR Information (2) <sup>(1)</sup>**

Address	Register	Symbol	After Reset
0040h			
0041h			
0042h			
0043h			
0044h	INT3 Interrupt Control Register	INT3IC	XX00X000b
0045h	Timer B5 Interrupt Control Register	TB5IC	XXXXX000b
0046h	Timer B4 Interrupt Control Register, UART1 BUS Collision Detection Interrupt Control Register	TB4IC, U1BCNIC	XXXXX000b
0047h	Timer B3 Interrupt Control Register, UART0 BUS Collision Detection Interrupt Control Register	TB3IC, U0BCNIC	XXXXX000b
0048h	SI/O4 Interrupt Control Register, INT5 Interrupt Control Register	S4IC, INT5IC	XX00X000b
0049h	SI/O3 Interrupt Control Register, INT4 Interrupt Control Register	S3IC, INT4IC	XX00X000b
004Ah	UART2 Bus Collision Detection Interrupt Control Register	BCNIC	XXXXX000b
004Bh	DMA0 Interrupt Control Register	DM0IC	XXXXX000b
004Ch	DMA1 Interrupt Control Register	DM1IC	XXXXX000b
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	UART2 Transmit Interrupt Control Register	S2TIC	XXXXX000b
0050h	UART2 Receive Interrupt Control Register	S2RIC	XXXXX000b
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	S0RIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	Timer A0 Interrupt Control Register	TA0IC	XXXXX000b
0056h	Timer A1 Interrupt Control Register	TA1IC	XXXXX000b
0057h	Timer A2 Interrupt Control Register	TA2IC	XXXXX000b
0058h	Timer A3 Interrupt Control Register	TA3IC	XXXXX000b
0059h	Timer A4 Interrupt Control Register	TA4IC	XXXXX000b
005Ah	Timer B0 Interrupt Control Register	TB0IC	XXXXX000b
005Bh	Timer B1 Interrupt Control Register	TB1IC	XXXXX000b
005Ch	Timer B2 Interrupt Control Register	TB2IC	XXXXX000b
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Fh	INT2 Interrupt Control Register	INT2IC	XX00X000b
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h			
0073h			
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

**NOTES:**

1. The blank areas are reserved and cannot be accessed by users.

X : Nothing is mapped to this bit

$$V_{CC1}=V_{CC2}=3V$$

**Table 5.30 Electrical Characteristics (1) <sup>(1)</sup>**

Symbol	Parameter		Measuring Condition	Standard			Unit
				Min.	Typ.	Max.	
VOH	HIGH Output Voltage <sup>(3)</sup>	P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1	IOH=−1mA	V <sub>CC1</sub> −0.5		V <sub>CC1</sub>	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7	IOH=−1mA <sup>(2)</sup>	V <sub>CC2</sub> −0.5		V <sub>CC2</sub>	
VOH	HIGH Output Voltage XOUT	HIGHPOWER	IOH=−0.1mA	V <sub>CC1</sub> −0.5		V <sub>CC1</sub>	V
		LOWPOWER	IOH=−50μA	V <sub>CC1</sub> −0.5		V <sub>CC1</sub>	
	HIGH Output Voltage XCOUT	HIGHPOWER	With no load applied		2.5		V
		LOWPOWER	With no load applied		1.6		
VOL	LOW Output Voltage <sup>(3)</sup>	P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1	IOL=1mA			0.5	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7	IOL=1mA <sup>(2)</sup>			0.5	
VOL	LOW Output Voltage XOUT	HIGHPOWER	IOL=0.1mA			0.5	V
		LOWPOWER	IOL=50μA			0.5	
	LOW Output Voltage XCOUT	HIGHPOWER	With no load applied		0		V
		LOWPOWER	With no load applied		0		
VT+−VT−	Hysteresis	HOLD, RDY, TA0IN to TA4IN, TB0IN to TB5IN, INT0 to INT5, NMI, ADTRG, CTS0 to CTS2, CLK0 to CLK4, TA0OUT to TA4OUT, KI0 to KI3, RXD0 to RXD2, SCL0 to SCL2, SDA0 to SDA2, SIN3, SIN4		0.2		0.8	V
VT+−VT−	Hysteresis	RESET		0.2	(0.7)	1.8	V
I <sub>IH</sub>	HIGH Input Current <sup>(3)</sup>	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1, XIN, RESET, CNVSS, BYTE	VI=3V			4.0	μA
I <sub>IL</sub>	LOW Input Current <sup>(3)</sup>	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1, XIN, RESET, CNVSS, BYTE	VI=0V			−4.0	μA
RPULLUP	Pull-Up Resistance <sup>(3)</sup>	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1	VI=0V	50	100	500	kΩ
R <sub>FXIN</sub>	Feedback Resistance XIN				3.0		MΩ
R <sub>FXIN</sub>	Feedback Resistance XCIN				25		MΩ
V <sub>RAM</sub>	RAM Retention Voltage		At stop mode	2.0			V

**NOTES:**

1. Referenced to V<sub>CC1</sub> = V<sub>CC2</sub> = 2.7 to 3.3V, V<sub>SS</sub> = 0V at T<sub>opr</sub> = −20 to 85°C / −40 to 85°C, f(XIN)=10MHz no wait unless otherwise specified.
2. V<sub>CC1</sub> for the port P6 to P11 and P14, and V<sub>CC2</sub> for the port P0 to P5 and P12 to P13
3. There is no external connections for port P1\_0 to P1\_7, P4\_4 to P4\_7, P7\_2 to P7\_5 and P9\_1 in 80-pin version.

$$V_{CC1}=V_{CC2}=3V$$

**Switching Characteristics**

( $V_{CC1} = V_{CC2} = 3V$ ,  $V_{SS} = 0V$ , at  $T_{opr} = -20$  to  $85^{\circ}C$  /  $-40$  to  $85^{\circ}C$  unless otherwise specified)

**Table 5.46 Memory Expansion and Microprocessor Modes (for setting with no wait)**

Symbol	Parameter		Standard		Unit
			Min.	Max.	
$t_d(BCLK-AD)$	Address Output Delay Time	See Figure 5.12		30	ns
$t_h(BCLK-AD)$	Address Output Hold Time (in relation to BCLK)		4		ns
$t_h(RD-AD)$	Address Output Hold Time (in relation to RD)		0		ns
$t_h(WR-AD)$	Address Output Hold Time (in relation to WR)		(NOTE 2)		ns
$t_d(BCLK-CS)$	Chip Select Output Delay Time			30	ns
$t_h(BCLK-CS)$	Chip Select Output Hold Time (in relation to BCLK)		4		ns
$t_d(BCLK-ALE)$	ALE Signal Output Delay Time			25	ns
$t_h(BCLK-ALE)$	ALE Signal Output Hold Time		-4		ns
$t_d(BCLK-RD)$	RD Signal Output Delay Time			30	ns
$t_h(BCLK-RD)$	RD Signal Output Hold Time		0		ns
$t_d(BCLK-WR)$	WR Signal Output Delay Time			30	ns
$t_h(BCLK-WR)$	WR Signal Output Hold Time		0		ns
$t_d(BCLK-DB)$	Data Output Delay Time (in relation to BCLK)			40	ns
$t_h(BCLK-DB)$	Data Output Hold Time (in relation to BCLK) <sup>(3)</sup>		4		ns
$t_d(DB-WR)$	Data Output Delay Time (in relation to WR)		(NOTE 1)		ns
$t_h(WR-DB)$	Data Output Hold Time (in relation to WR) <sup>(3)</sup>		(NOTE 2)		ns
$t_d(BCLK-HLDA)$	HLDA Output Delay Time			40	ns

**NOTES:**

1. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(BCLK)} - 40 [ns] \quad f(BCLK) \text{ is } 12.5MHz \text{ or less.}$$

2. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(BCLK)} - 10 [ns]$$

3. This standard value shows the timing when the output is off, and does not show hold time of data bus.

Hold time of data bus varies with capacitor volume and pull-up (pull-down) resistance value.

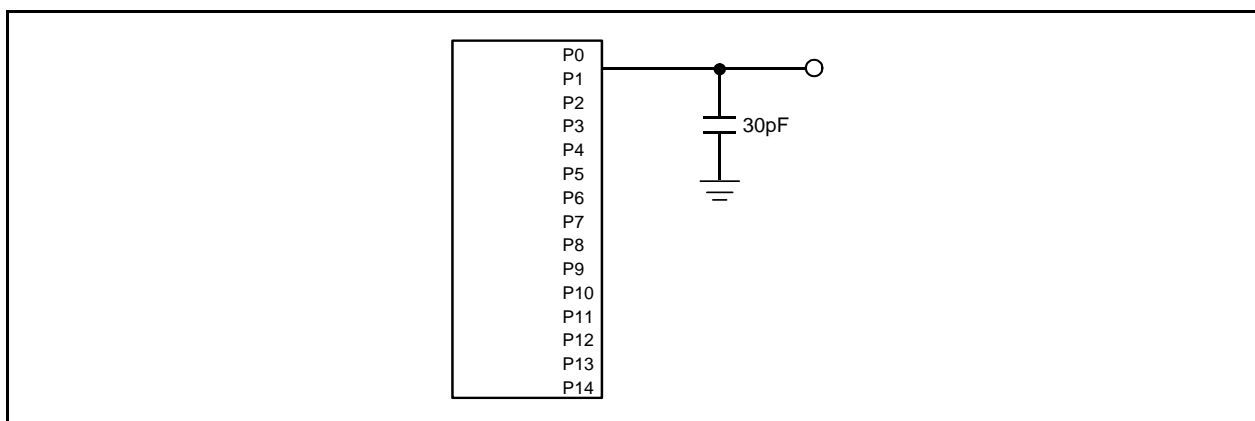
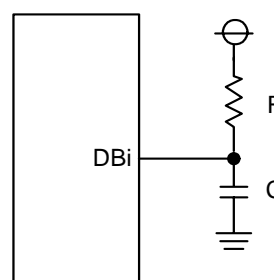
Hold time of data bus is expressed in

$$t = -CR \times \ln(1 - V_{OL} / V_{CC2})$$

by a circuit of the right figure.

For example, when  $V_{OL} = 0.2V_{CC2}$ ,  $C = 30pF$ ,  $R = 1k\Omega$ , hold time of output "L" level is

$$t = -30pF \times 1k\Omega \times \ln(1 - 0.2V_{CC2} / V_{CC2}) = 6.7ns.$$

**Figure 5.12 Ports P0 to P14 Measurement Circuit**

$$V_{CC1}=V_{CC2}=3V$$

**Switching Characteristics**

( $V_{CC1} = V_{CC2} = 5V$ ,  $V_{SS} = 0V$ , at  $T_{opr} = -20$  to  $85^{\circ}C$  /  $-40$  to  $85^{\circ}C$  unless otherwise specified)

**Table 5.47 Memory Expansion and Microprocessor Modes (for 1- to 3-wait setting and external area access)**

Symbol	Parameter		Standard		Unit
			Min.	Max.	
$t_d(BCLK-AD)$	Address Output Delay Time	See Figure 5.12		30	ns
$t_h(BCLK-AD)$	Address Output Hold Time (in relation to BCLK)		4		ns
$t_h(RD-AD)$	Address Output Hold Time (in relation to RD)		0		ns
$t_h(WR-AD)$	Address Output Hold Time (in relation to WR)		(NOTE 2)		ns
$t_d(BCLK-CS)$	Chip Select Output Delay Time			30	ns
$t_h(BCLK-CS)$	Chip Select Output Hold Time (in relation to BCLK)		4		ns
$t_d(BCLK-ALE)$	ALE Signal Output Delay Time			25	ns
$t_h(BCLK-ALE)$	ALE Signal Output Hold Time		-4		ns
$t_d(BCLK-RD)$	RD Signal Output Delay Time			30	ns
$t_h(BCLK-RD)$	RD Signal Output Hold Time		0		ns
$t_d(BCLK-WR)$	WR Signal Output Delay Time			30	ns
$t_h(BCLK-WR)$	WR Signal Output Hold Time		0		ns
$t_d(BCLK-DB)$	Data Output Delay Time (in relation to BCLK)			40	ns
$t_h(BCLK-DB)$	Data Output Hold Time (in relation to BCLK) <sup>(3)</sup>		4		ns
$t_d(DB-WR)$	Data Output Delay Time (in relation to WR)		(NOTE 1)		ns
$t_h(WR-DB)$	Data Output Hold Time (in relation to WR) <sup>(3)</sup>		(NOTE 2)		ns
$t_d(BCLK-HLDA)$	HLDA Output Delay Time			40	ns

**NOTES:**

1. Calculated according to the BCLK frequency as follows:

$$\frac{(n-0.5) \times 10^9}{f(BCLK)} - 40[ns]$$

n is "1" for 1-wait setting, "2" for 2-wait setting and "3" for 3-wait setting.  
(BCLK) is 12.5MHz or less.

2. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(BCLK)} - 10[ns]$$

3. This standard value shows the timing when the output is off, and does not show hold time of data bus.

Hold time of data bus varies with capacitor volume and pull-up (pull-down) resistance value.

Hold time of data bus is expressed in

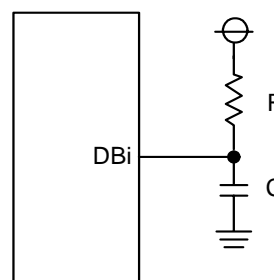
$$t = -CR \times \ln(1 - V_{OL} / V_{CC2})$$

by a circuit of the right figure.

For example, when  $V_{OL} = 0.2V_{CC2}$ ,  $C = 30pF$ ,  $R = 1k\Omega$ , hold time of output "L" level is

$$t = -30pF \times 1k\Omega \times \ln(1 - 0.2V_{CC2} / V_{CC2})$$

$$= 6.7ns.$$



$$V_{CC1}=V_{CC2}=3V$$

**Switching Characteristics**

( $V_{CC1} = V_{CC2} = 5V$ ,  $V_{SS} = 0V$ , at  $T_{opr} = -20$  to  $85^{\circ}C$  /  $-40$  to  $85^{\circ}C$  unless otherwise specified)

**Table 5.48 Memory Expansion and Microprocessor Modes (for 2- to 3-wait setting, external area access and multiplex bus selection)**

Symbol	Parameter		Standard		Unit
			Min.	Max.	
$t_d(BCLK-AD)$	Address Output Delay Time	See Figure 5.12		50	ns
$t_h(BCLK-AD)$	Address Output Hold Time (in relation to BCLK)		4		ns
$t_h(RD-AD)$	Address Output Hold Time (in relation to RD)		(NOTE 1)		ns
$t_h(WR-AD)$	Address Output Hold Time (in relation to WR)		(NOTE 1)		ns
$t_d(BCLK-CS)$	Chip Select Output Delay Time			50	ns
$t_h(BCLK-CS)$	Chip Select Output Hold Time (in relation to BCLK)		4		ns
$t_h(RD-CS)$	Chip Select Output Hold Time (in relation to RD)		(NOTE 1)		ns
$t_h(WR-CS)$	Chip Select Output Hold Time (in relation to WR)		(NOTE 1)		ns
$t_d(BCLK-RD)$	RD Signal Output Delay Time			40	ns
$t_h(BCLK-RD)$	RD Signal Output Hold Time		0		ns
$t_d(BCLK-WR)$	WR Signal Output Delay Time			40	ns
$t_h(BCLK-WR)$	WR Signal Output Hold Time		0		ns
$t_d(BCLK-DB)$	Data Output Delay Time (in relation to BCLK)			50	ns
$t_h(BCLK-DB)$	Data Output Hold Time (in relation to BCLK)		4		ns
$t_d(DB-WR)$	Data Output Delay Time (in relation to WR)		(NOTE 2)		ns
$t_h(WR-DB)$	Data Output Hold Time (in relation to WR)		(NOTE 1)		ns
$t_d(BCLK-HLDA)$	HLDA Output Delay Time			40	ns
$t_d(BCLK-ALE)$	ALE Signal Output Delay Time (in relation to BCLK)			25	ns
$t_h(BCLK-ALE)$	ALE Signal Output Hold Time (in relation to BCLK)		-4		ns
$t_d(AD-ALE)$	ALE Signal Output Delay Time (in relation to Address)		(NOTE 3)		ns
$t_h(AD-ALE)$	ALE Signal Output Hold Time (in relation to Address)		(NOTE 4)		ns
$t_d(AD-RD)$	RD Signal Output Delay From the End of Address		0		ns
$t_d(AD-WR)$	WR Signal Output Delay From the End of Address		0		ns
$t_{dz}(RD-AD)$	Address Output Floating Start Time			8	ns

**NOTES:**

1. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(BCLK)} - 10 [ns]$$

2. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(BCLK)} - 50 [ns] \quad n \text{ is "2" for 2-wait setting, "3" for 3-wait setting.}$$

3. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(BCLK)} - 40 [ns]$$

4. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(BCLK)} - 15 [ns]$$

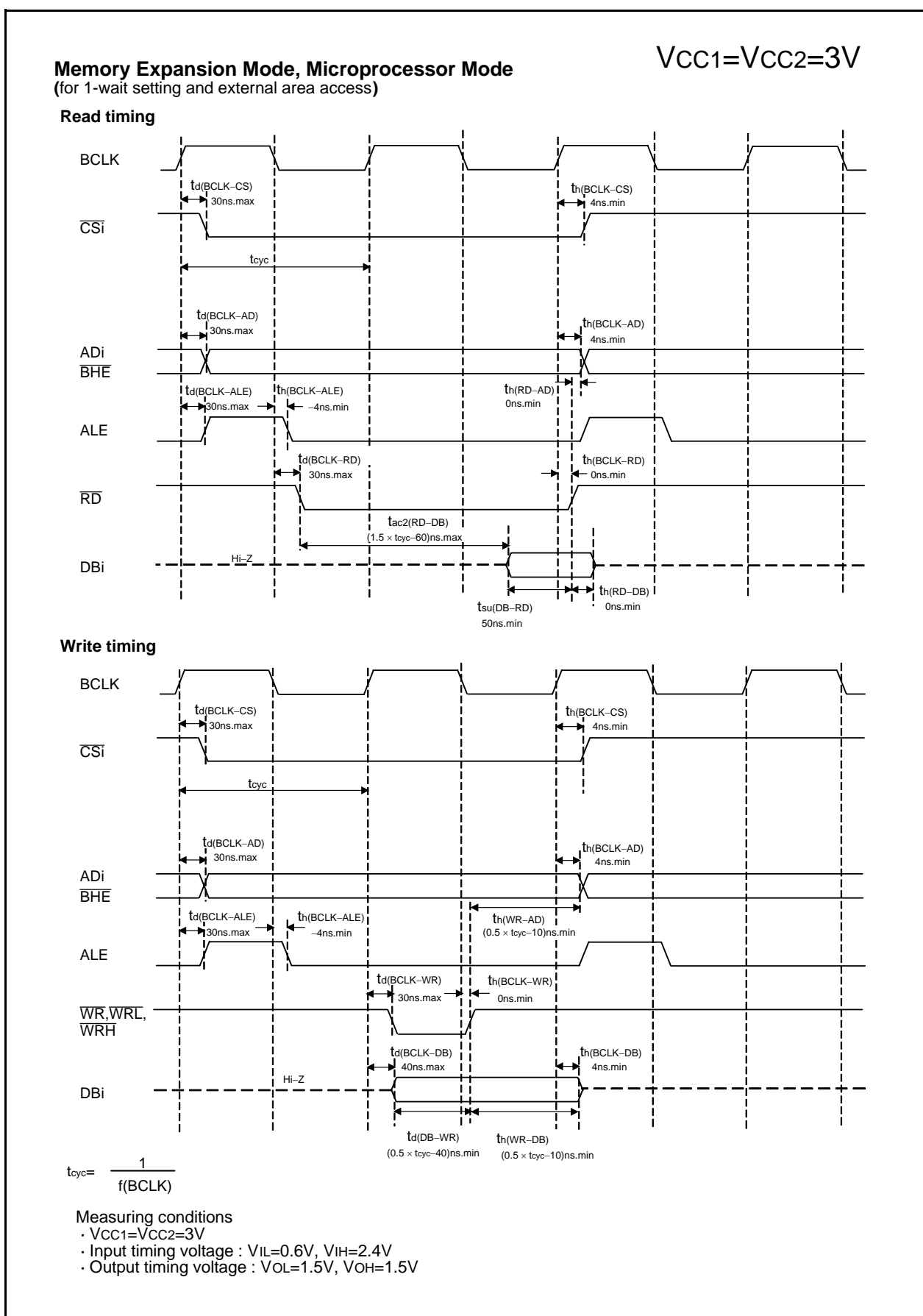
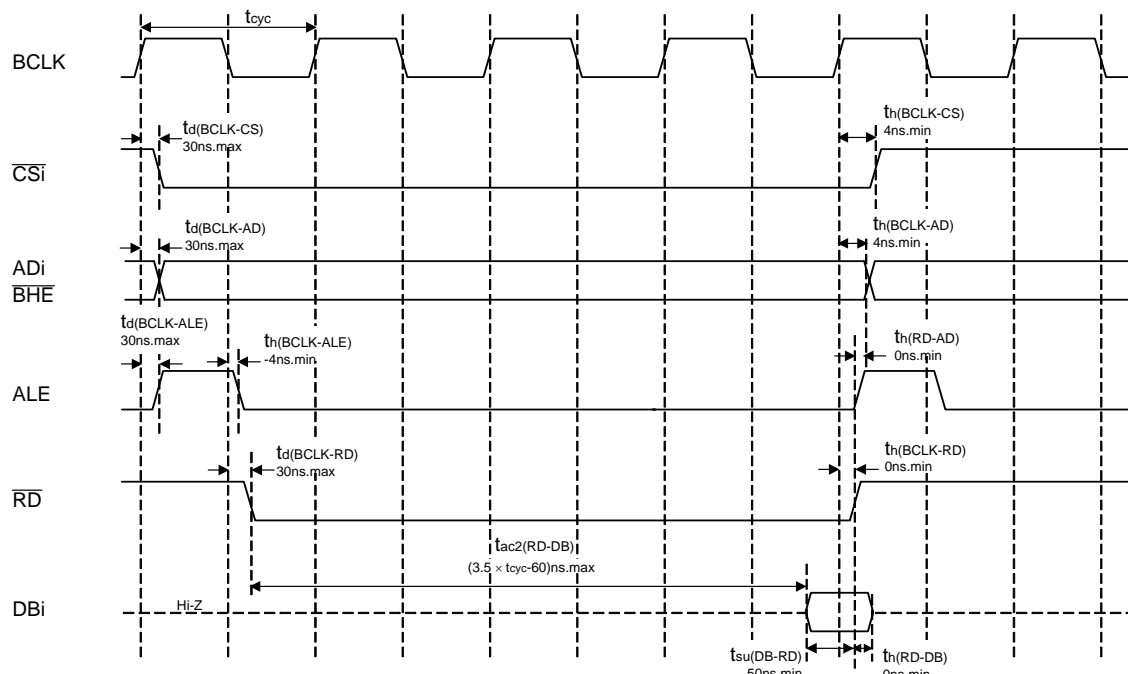
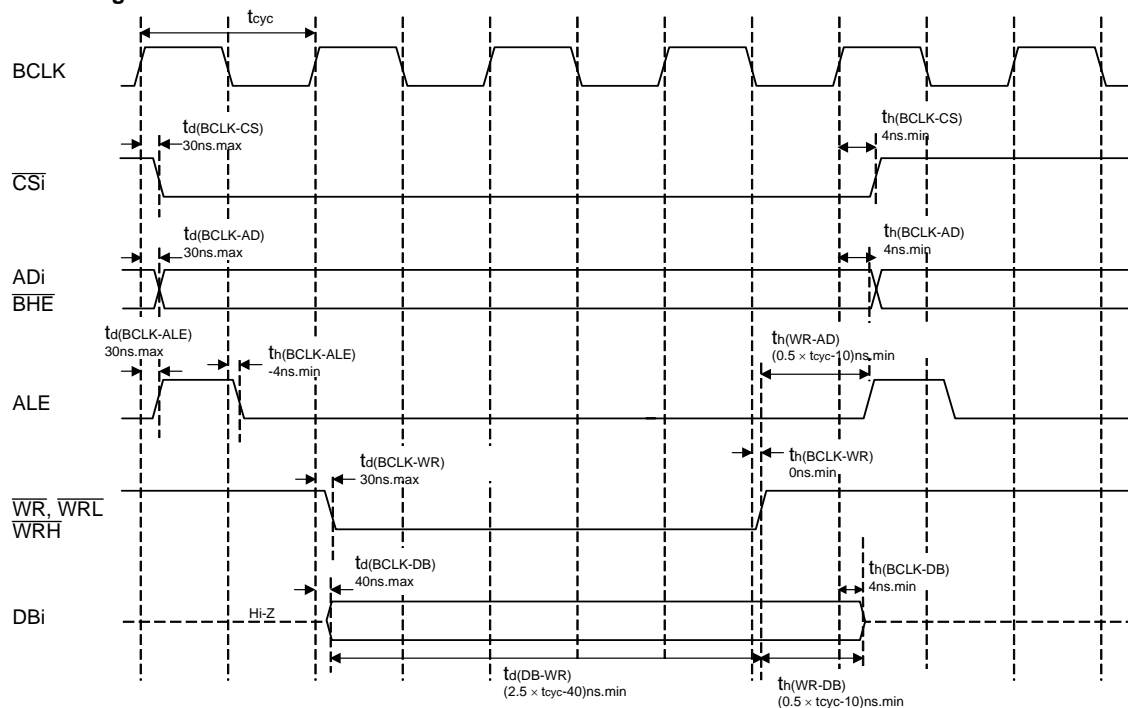


Figure 5.17 Timing Diagram (5)

**Memory Expansion Mode, Microprocessor Mode**  
 (for 3-wait setting and external area access)

$$V_{CC1} = V_{CC2} = 3V$$

**Read timing**

**Write timing**


$$t_{cyc} = \frac{1}{f(BCLK)}$$

**Measuring conditions**

- $V_{CC1}=V_{CC2}=3V$
- Input timing voltage :  $V_{IL}=0.6V$ ,  $V_{IH}=2.4V$
- Output timing voltage :  $V_{OL}=1.5V$ ,  $V_{OH}=1.5V$

**Figure 5.19 Timing Diagram (7)**



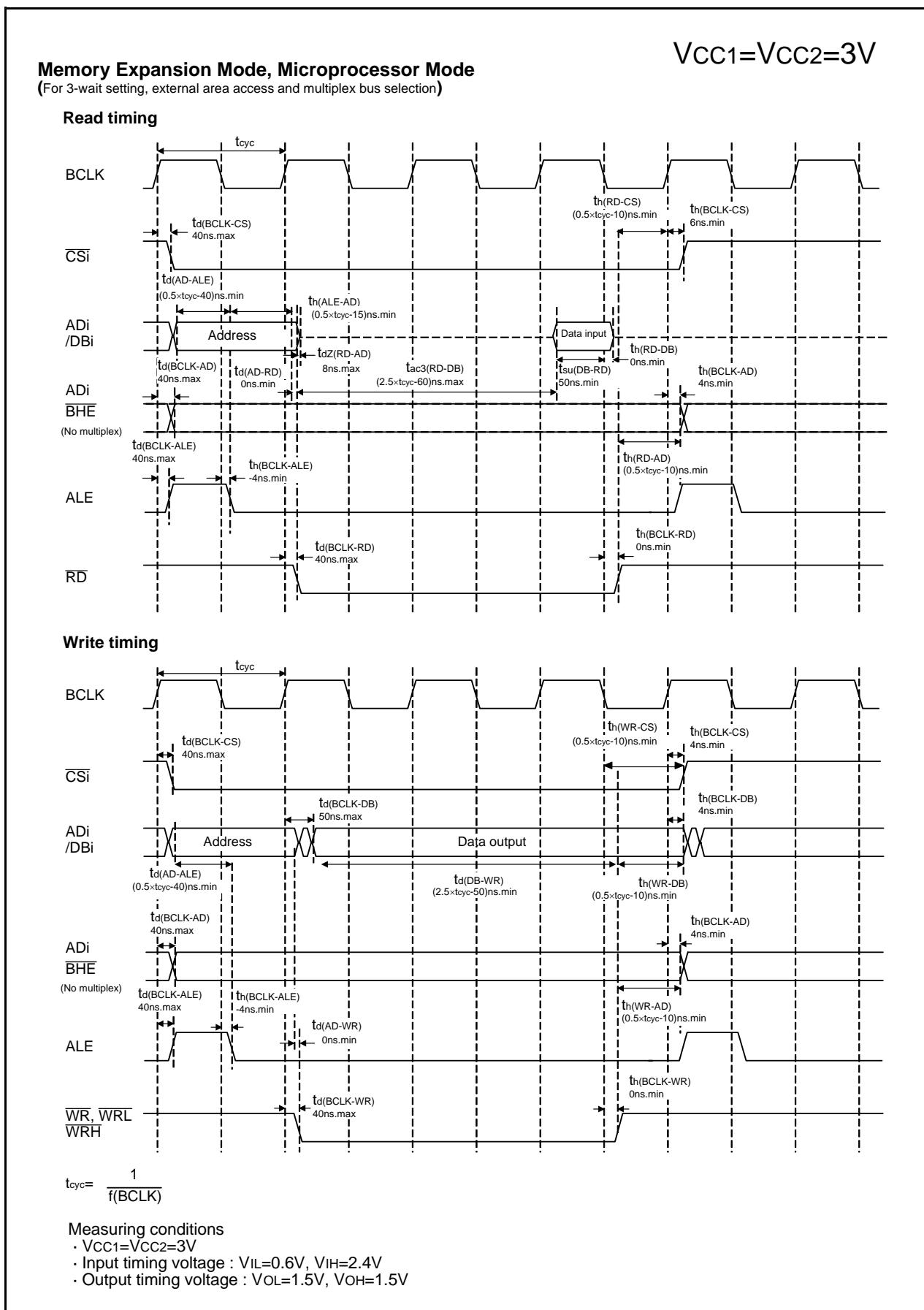


Figure 5.21 Timing Diagram (9)

## 5.2 Electrical Characteristics (M16C/62PT)

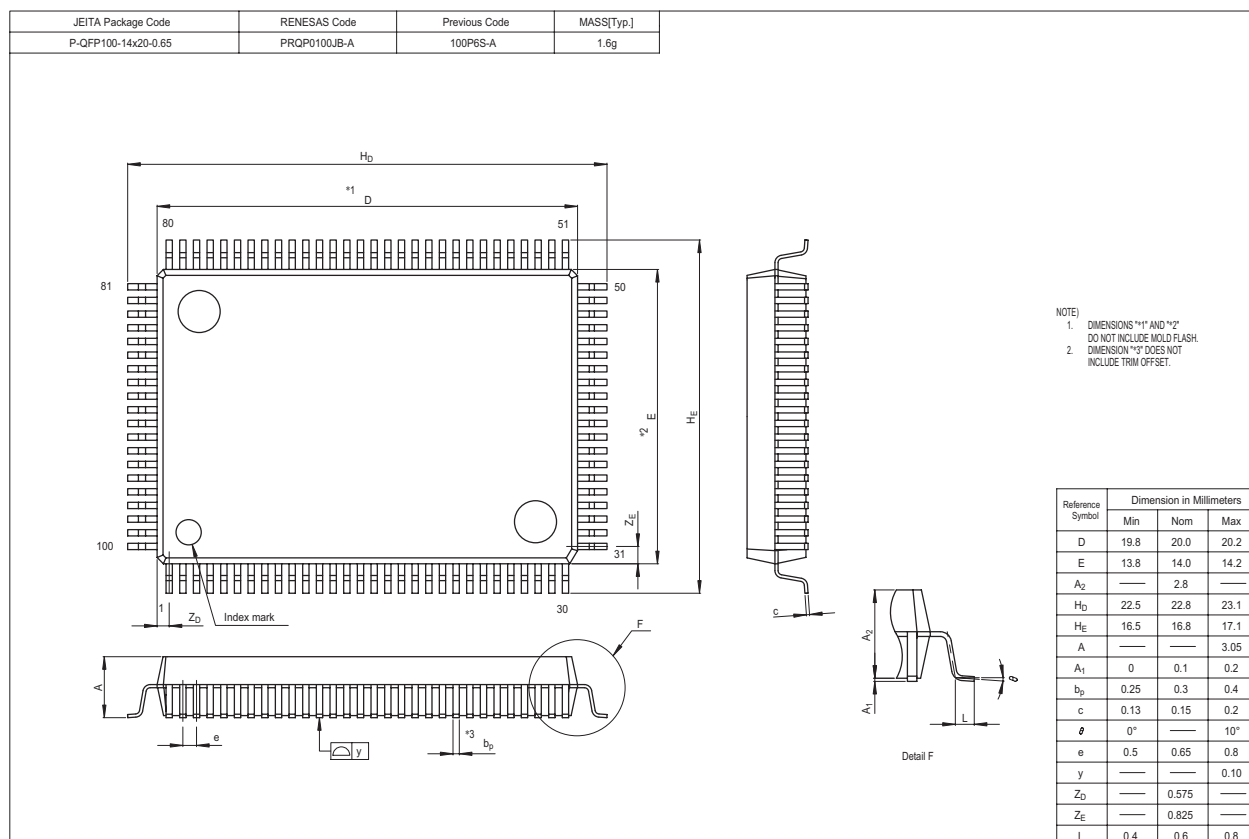
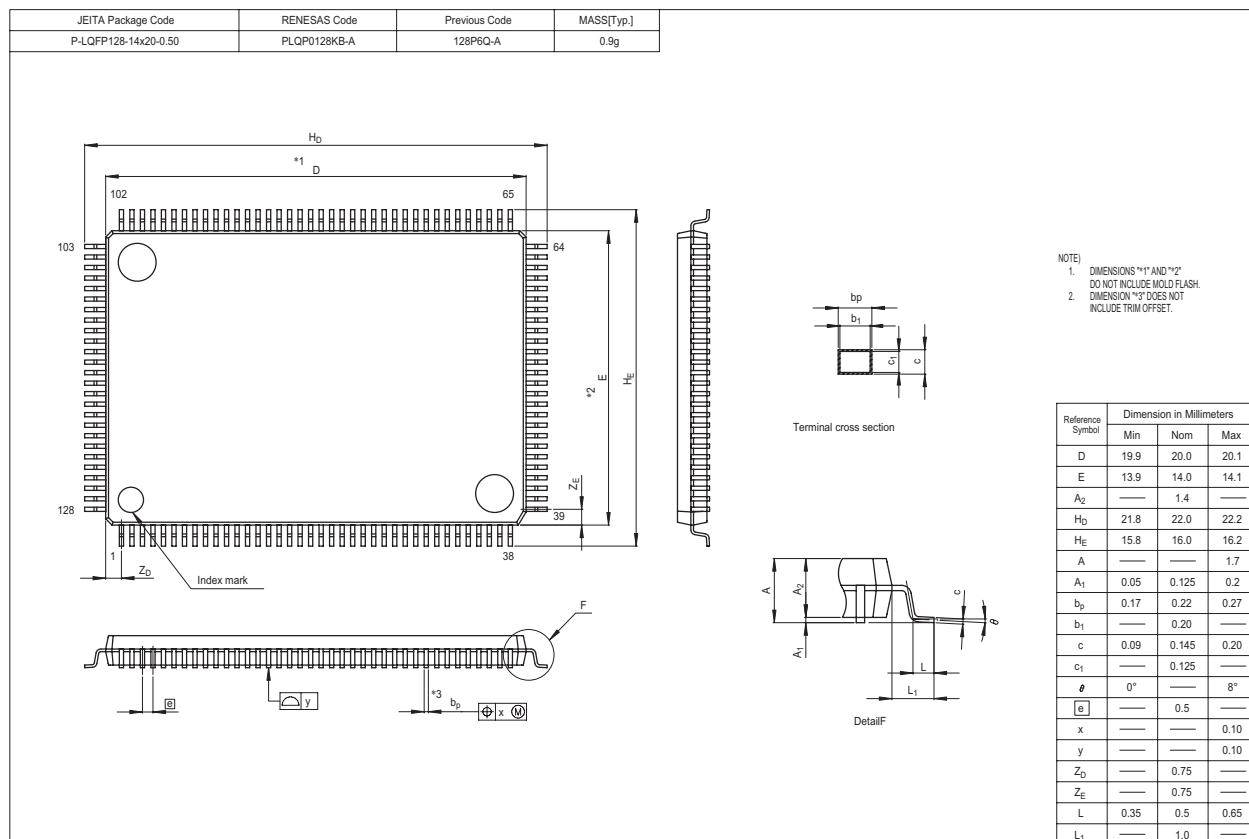
**Table 5.49 Absolute Maximum Ratings**

Symbol	Parameter		Condition	Rated Value	Unit
V <sub>CC1</sub> , V <sub>CC2</sub>	Supply Voltage		V <sub>CC1</sub> =V <sub>CC2</sub> =AV <sub>CC</sub>	−0.3 to 6.5	V
AV <sub>CC</sub>	Analog Supply Voltage		V <sub>CC1</sub> =V <sub>CC2</sub> =AV <sub>CC</sub>	−0.3 to 6.5	V
V <sub>I</sub>	Input Voltage	RESET, CNVSS, BYTE, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1, VREF, XIN		−0.3 to V <sub>CC1</sub> +0.3 <sup>(1)</sup>	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7		−0.3 to V <sub>CC2</sub> +0.3 <sup>(1)</sup>	V
		P7_0, P7_1		−0.3 to 6.5	V
V <sub>O</sub>	Output Voltage	P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1, XOUT		−0.3 to V <sub>CC1</sub> +0.3 <sup>(1)</sup>	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7		−0.3 to V <sub>CC2</sub> +0.3 <sup>(1)</sup>	V
		P7_0, P7_1		−0.3 to 6.5	V
P <sub>d</sub>	Power Dissipation		−40°C<T <sub>opr</sub> ≤85°C	300	mW
			85°C<T <sub>opr</sub> ≤125°C	200	
T <sub>opr</sub>	Operating Ambient Temperature	When the Microcomputer is Operating		−40 to 85 / −40 to 125 <sup>(2)</sup>	°C
		Flash Program Erase		0 to 60	
T <sub>stg</sub>	Storage Temperature			−65 to 150	°C

**NOTES:**

1. There is no external connections for port P1\_0 to P1\_7, P4\_4 to P4\_7, P7\_2 to P7\_5 and P9\_1 in 80-pin version.
2. T version = −40 to 85 °C, V version= −40 to 125 °C.

## Appendix 1.Package Dimensions



# REVISION HISTORY

M16C/62P Group (M16C/62P, M16C/62PT) Hardware Manual

Rev.	Date	Description	
		Page	Summary
1.10	May 28, 2003	1	Applications are partly revised.
		2	Table 1.1.1 is partly revised.
		4-5	Table 1.1.2 and 1.1.3 is partly revised. “Note 1” is partly revised.
		22	Table 1.5.3 is partly revised.
		23	Table 1.5.5 is partly revised. Table 1.5.6 is added.
		24	Table 1.5.9 is partly revised.
		30	Notes 1 and 2 in Table 1.5.26 is partly revised.
		31	Notes 1 in Table 1.5.27 is partly revised.
		30-31	Note 3 is added to “Data output hold time (refers to BCLK)” in Table 1.5.26 and 1.5.27.
		32	Note 4 is added to “th(ALE-AD)” in Table 1.5.28.
		30-32	Switching Characteristics is partly revised.
		36-39	th(WR-AD) and th(WR-DB) in Figure 1.5.5 to 1.5.8 is partly revised.
		40-41	th(ALE-AD), th(WR-CS), th(WR-DB) and th(WR-AD) in Figure 1.5.9 to 1.5.10 is partly revised.
		42	Note 2 is added to Table 1.5.29.
		47	Notes 1 and 2 in Table 1.5.45 is partly revised.
		48	Notes 1 in Table 1.5.46 is partly revised.
		47-48	Note 3 is added to “Data output hold time (refers to BCLK)” in Table 1.5.45 and 1.5.46.
		49	Note 4 is added to “th(ALE-AD)” in Table 1.5.47.
		47-48	Switching Characteristics is partly revised.
		53-56	th(WR-AD) and th(WR-DB) in Figure 1.5.15 to 1.5.18 is partly revised.
		57-58	th(ALE-AD), th(WR-CS), th(WR-DB) and th(WR-AD) in Figure 1.5.19 to 1.5.20 is partly revised.
2.00	Oct 29, 2003	-	Since high reliability version is added, a group name is revised. M16C/62 Group (M16C/62P) → M16C/62 Group (M16C/62P, M16C/62PT)
		2-4	Table 1.1 to 1.3 are revised. Note 3 is partly revised.
		2-4	Table 1.1 to 1.3 are revised. Note 3 is partly revised.
		6	Figure 1.2 Note5 is deleted.
		7-9	Table 1.4 to 1.7 Product List is partly revised.
		11	Table 1.8 and Figure 1.4 are added.
		12-15	Figure 1.5 to 1.9 ZP is added.
		17,19	Table 1.10 and 1.12 ZP is added to timer A.
		18,20	Table 1.11 and 1.13 VCC1 is added to VREF.
		30	Table 5.1 is revised.
		31-32	Table 5.2 and 5.3 are revised.

REVISION HISTORY		M16C/62P Group (M16C/62P, M16C/62PT) Hardware Manual	
Rev.	Date	Description	
		Page	Summary
		33 34,74 36 38,55 41 41-43, 58-60 44 47-48 49-50 52 53 58 61 64-65 66-67 69 70-85	Table 5.4 A-D Conversion Characteristics is revised. Table 5.5 D-A Conversion Characteristics revised. Table 5.6 to 5.7 and table 5.54 to 5.55 are revised. Table 5.11 is revised. Table 5.14 and 5.33 HLDA output delay time is deleted. Figure 5.1 is partly revised. Table 5.27 to 5.29 and table 5.46 to 48 HLDA output delay time is added. Figure 5.2 Timing Diagram (1) XIN input is added. Figure 5.5 to 5.6 Read timing DB → DBi Figure 5.7 to 5.8 Write timing DB → DBi Figure 5.10 DB → DBi Table 5.30 is revised. Figure 5.11 is partly revised. Figure 5.12 Timing Diagram (1) XIN input is added. Figure 5.15 to 5.16 Read timing DB → DBi Figure 5.17 to 5.18 Write timing DB → DBi Figure 5.20 DB → DBi Electrical Characteristics (M16C/62PT) is added.
2.10	Nov 07, 2003	8-9 23 71 72	Table 1.5 to 1.7 Product List is partly revised. Note 1 is deleted. Table 3.1 is revised. Table 5.50 is revised. Table 5.51 is deleted.
2.11	Jan 06, 2004	16 17-18 31	Table 1.9 NOTE 3 VCC1 VCC2 → VCC1 > VCC2 Table 1.10 to 1.11 NOTE 1 VCC1 VCC2 → VCC1 > VCC2 Table 5.2 Power Supply Ripple Allowable Frequency Unit MHz → kHz
2.30	Sep 01, 2004	12 18, 20 19,21 24 25 33 34 35 37	Table 1.9 and Figure 1.5 are added. Table 1.11 to 1.13 are revised. Table 1.12 to 1.14 are revised. Figure 3.1 is partly revised. Note 3 is added. Note 6 is added. Table 5.3 is revised. Note 2 in Table 5.4 is added. Table 5.5 to 5.6 is partly revised. Table 5.8 is revised. Table 5.9 is revised. Table 5.11 is revised.